

N/A Orders received after the Current Material Last Order Date expiration are to be considered as orders for new changed material as described in this PCN. Orders for current (unchanged) material after this date will be per mutual agreement and current material inventory availability. Current Material Last Delivery Date: N/A The Current Material Last Delivery Date may be subject to change based on build and depletion of the current (unchanged) material inventory Product Category: Active components – Integrated circuits Contact information: Contact your local onsemi Sales Office or Giretel.Ines@onsemi.com PCN Samples Contact: Contact your local onsemi Sales Office to place sample order. Sample sequence contact: Sample requests are to be submitted no later than 45 days after publication of this change notification. Samples Contact: Contact your local onsemi Sales Office or Nuel Matorag@onsemi.com Type of Notification: Contact your local onsemi Sales Office or Nuel Matorag@onsemi.com Type of Notification: This is an initial Product/Process Change Notification (PCN) sent to customers. An IPCN is an advance notification and characterization date will be followed by a Final Product/Process Change Notification (PCN) at least 6 months prior to implementation of the change. In case of questions, contact <pcn.support@onsemi.com< td=""> Type of Notification: This is an initial Product/Process Change Notification (PCN) at least 6 months prior to implementeteen of the change. In case of questions, contact <pcn.support@on< th=""><th>Title of Change:</th><th colspan="2">Update to IPCN2475 wire for TSSOP HSL d</th><th>12 - Cancellation of project on Qualification of Tanaka 0.8mil Soft PCC evices at ASM.</th></pcn.support@on<></pcn.support@onsemi.com<>	Title of Change:	Update to IPCN2475 wire for TSSOP HSL d		12 - Cancellation of project on Qualification of Tanaka 0.8mil Soft PCC evices at ASM.		
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onsemi Sites External Foundry/Subcon Sites	Anticipated impact on fit, form, function, reliability, product safety or manufacturability:					
	Sites Affected:					
onsemi Carmona, Philippines None	onsemi Sites			External Foundry/Subcon Sites		
	onsemi Carmona, Philippines			None		



Marking of Parts/ Traceability of Change:	There will be no change on product marking.				
Reliability Data Summary:					
Not applicable since project will be cancelled.					
Electrical Characteristics Summary:					
Electrical characteristics are not impacted.					

List of Affected Parts:

Note: Only the standard (off the shelf) part numbers are listed in the parts list. Any custom parts affected by this PCN are shown in the customer specific PCN addendum in the PCN email notification, or on the <u>PCN Customized Portal</u>.

Current Part Number	New Part Number	Qualification Vehicle	
NLV74HC74ADTR2G	NA	NLV74HC74ADTR2G / NLVHC4851ADTR2G	

Appendix A: Changed Products

DIKG: DIGI-KEY

Product	Customer Part Number	Qualification Vehicle	New Part Number	Replacement Supplier
NLV74HC74ADTR2G		NLV74HC74ADTR2G	NA	
		/		
		NLVHC4851ADTR2G		